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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/725,938	12/03/2003	Holger Hoppe	QIM 2002 P 50212 US	4491
68/038 7590 08/29/2008 SLATER & MATSIL, L.L.P. 17950 PRESTON ROAD SUITE 1000 DALLAS, TX 75252				
EXAMINER				
NGUYEN, VINH P				
ART UNIT		PAPER NUMBER		
2829				
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08/29/2008		PAPER		

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary

Application No.

10/725,938

Applicant(s)

HOPPE, HOLGER

Examiner

VINH P. NGUYEN

Art Unit

2829

Period for Reply -- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 11 June 2008.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-11, 15-18, 23, 25 and 30-39 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-11, 15-18, 23, 25 and 30-39 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 10/18/06 and 12/03/03 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) ☐ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsman's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO/SB/08)
Paper No(s)/Mail Date _____
- 4) ☐ Interview Summary (PTO-413)
Paper No(s)/Mail Date _____
- 5) ☐ Notice of Informal Patent Application
- 6) ☐ Other: _____

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 04/11/08 has been entered.
2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

3. Claims 1-11,15-18,23,25 and 35 and 39 are rejected under 35 U.S.C. 103(a) as being unpatentable over Matsuda (Pat # 4,730,156) in view of Famworth (Pat # 6,369,595).

As to claims 1, 35 and 36, Matsuda discloses in figure # 2 an apparatus for testing contacting between a semiconductor chip and a carrier having a carrier (16a, 16b, 16c, 16d) for coupling to a semiconductor chip (10a, 10b, 10c, 10d) and a plurality of contacting test contacts (162a, 162b, 162c, 162d) for exclusively testing the contacting between the semiconductor chip and the carrier (16a,16b,16c,16d). It is noted that the carrier (16a,16b,16c,16d) is considered as a "test carrier" since it is connected to a detection circuit (30,32,34,36) and the semiconductor chip is directly contacted with the contacts (14) of the test carrier (16a, 16,16c, 16d). Masuda does not mention about unloading the semiconductor device from the test carrier based on criterion from the test. However, it would have been obvious for one of ordinary skill in the art to remove the semiconductor device from the circuit board in response to the test result indicated that it is not correctly inserted into the carrier/circuit board (16a,16b,16c,16d).

As to claim 2, it appears that the carrier (16a, 16b, 16c, 16d) electrically coupled to a testing apparatus (30, 34, 32, 36) by wires/conductors connected to the test contacts (162a, 162b, 162c, 162d).

As to claim 3, it appears that the carrier is connected to the testing apparatus and the carrier (16a, 16b, 16c, 16d) is subsequently loaded with semiconductor chip (10a, 10b, 10c, 10d).

As to claim 4, it appears that the carrier (16a, 16b, 16c, 16d) is inherently loaded at a carrier loading station and the contacting between the carrier and the semiconductor chip is tested before the carrier is transported to a further station after all tests are done.

As to claim 5, the contacting between the carrier and the chip is tested by the testing apparatus (30, 32, 34, 36).

As to claims 6 and 39, the device of Matsuda is configured to test the contacting between the carrier and the semiconductor chip but not functioning of the chip.

As to claim 7, performing the contacting between the carrier and the semiconductor chip being tested by the testing apparatus (34, 30, 32, 36) less than 2 seconds after loading of the carrier with the chip is considered as an inherent function of the testing apparatus (30, 32, 34 and 36).

As to claims 8-9, the contacting testing between the carrier and the chip is determined whether an electric contact has been established between a corresponding pad • (104a, 106a, 104b, 106b, 104c, 106c, 104d, 106d) of the semiconductor chips (10a, 10b, 10c, 10d) and the assigned pads (162a, 164a, 162b, 164b, 162c, 164c, 162d, 164d) of the carrier (16a, 16b, 16c, 16d).

As to claim 10, it appears that there is a current flowing through the corresponding chip pad to the testing apparatus (30,34,32,36) in order to trigger the indicator (36) for indicating the electric contact between the chip and the carrier.

As to claim 11, when the contact between the semiconductor chip and the carrier is properly connected, the indicator (36) is lit up, that means there is an amount of voltage dropping across the chip. pad and that voltage is determined by the indicator (36).

As to claim 15, it appears that some of the contacting test contacts (see figure 2, test contacts on the upper left corner of the chip (10a, 10b, 10c, 10d) are not used during ordinary operation of the chip.

As to claims 16,18, Matsuda also discloses additional contact (104 or 106).

As to claim 17, the contacts (104a, 106a,104b,106b,104c,106c,104d,106d) are not used for testing the functioning of the chip during contacting test between the semiconductor chip and the carrier.

As to claim 23, Matsuda discloses one or more contacting test contacts (104a, 106a, 104b, 106b, 104c, 106c, 104d, 106d) are provided on a bottom of the chip (10a,10b,10c,10d). 8.

As to claim 25, Matsuda discloses an apparatus for testing contacting between a semiconductor chip and a carrier. However, the carrier (16a,,16b, 16c,,16d) of Matsuda is not a TSOP test carrier.

Farnworth et al teach that it would have been well known to have the TSOP socket (31) (see column 8, lines 6-8).

It would have been obvious for one of ordinary skill in the art to consider that the carrier (16a,16b,16c,16d) of Matsuda et al is a TSOP test carrier as taught by Famworth et al since this type of the socket is well known in the art for supporting a certain IC package.

4. Claims 30-35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Matsuda (Pat # 4,730,156) .

As to claims 30 and 33-34, Matsuda discloses in figure # 2 an apparatus for testing contacting between a semiconductor chip and a carrier having a carrier/carrier adapter (16a, 16b, 16c, 16d) for coupling to a semiconductor chip (10a, 10b, 10c, 10d) and a plurality of contacting test contacts (162a, 162b, 162c, 162d) for exclusively testing the contacting between the semiconductor chip and the carrier/carrier adapter (16a,16b,16c,16d). It is noted that the carrier (16a,16b,16c,16d) is considered as a "test carrier" since it is connected to a contact tester (detection circuit (30,32,34,36)) and the semiconductor chip is directly contacted with the contacts (14) of the test carrier (16a, 16,16c, 16d). Masuda does not mention about a functional tester physically separated from the contact tester for testing an electrical functionality of semiconductor device with good electrical contacts between the semiconductor device and the carrier. However, it would have been obvious for one of ordinary skill in the art to further provide an additional functional tester separated for further testing the semiconductor devices in order to determine the proper electrical characteristic of the semiconductor.

As to claim 31, Masuda does not mention about unloading the semiconductor device from the test carrier based on criterion from the test. However, it would have been obvious for

one of ordinary skill in the art to remove the semiconductor device from the circuit board in response to the test result indicated that it is not correctly inserted into the carrier/circuit board (16a,16b,16c,16d).

As to claim 32, the type of the functional tester such as "burn-in test" is well known in the art.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to VINH P. NGUYEN whose telephone number is 571-272-1964. The examiner can normally be reached on 6:30AM-4:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, HA T. NGUYEN can be reached on 571-272-1678. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/VINH P NGUYEN/
Primary Examiner
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